

GDAŃSK UNIVERSITY OF TECHNOLOGY GY GY SU SU

Subject card

Subject name and code	Microelectromechanical Systems, PG_00048580								
Field of study	Electronics and Telecommunications								
Date of commencement of studies	February 2024		Academic year of realisation of subject			2023/	2023/2024		
Education level	second-cycle studies		Subject group		Optional subject group Subject group related to scientific research in the field of study				
Mode of study	Full-time studies		Mode of de	elivery		at the	at the university		
Year of study	1		Language of instruction			Polish			
Semester of study	1		ECTS credits			2.0			
Learning profile	general academic profile		Assessment form			assessment			
Conducting unit	Department of Microe	electronic Syste	ems -> Faculty	of Electronics,	Teleco	mmunic	ations and Ir	formatics	
Name and surname	Subject supervisor		dr hab. inż. Pi	iotr Płotka					
of lecturer (lecturers)	Teachers	dr hab. inż. P							
Lesson types and methods	Lesson type	Lecture	Tutorial	Laboratory	Project		Seminar	SUM	
of instruction	Number of study hours	15.0	0.0	0.0			15.0	30	
	E-learning hours inclu	uded: 0.0			1		1	•	
Learning activity and number of study hours	Learning activity	Participation i classes includ plan		Participation consultation h			tudy	SUM	
	Number of study hours	30		4.0		16.0		50	
Subject objectives	Introduction to MEMS technologies, presentation of recent developments in MEMS, as well as teachig of application of tools used for simulating of electronic circuits for designing of MEMS.								
Learning outcomes	Course outcome		Subject outcome			Method of verification			
	[K7_U06] can analyse the operation of components, circuits and systems related to the field of study; measure their parameters; examine technical specifications; interpret obtained results and draw conclusions		knowing the theoretical methods developed for analysis of electronic circuits and electro- mechanical analogies, applies them for analyses of systems containing mechanical as well as electronic elements			[SU1] Assessment of task fulfilment			
	[K7_U02] can perform tasks related to the field of study as well as formulate and solve problems applying recent knowledge of physics and other areas of science		is able to study necessary topics in physics and chemistry and apply the gained knowledge for modelling of operation of MEMS elements which he/she did not know earlier			[SU1] Assessment of task fulfilment			
	[K7_U07] can apply advanced methods of process and function support, specific to the field of study		is able to apply creatively computer aided design tools developed for electrical circuits in order to design complex electromechanical systems			[SU1] Assessment of task fulfilment			
	[K7_W03] Knows and understands, to an increased extent, the construction and operating principles of components and systems related to the field of study, including theories, methods and complex relationships between them and selected specific issues - appropriate for the curriculum.		knows and understands construction and operation mechanisms of basic MEMS elements representative for applications in various fields		[SW1] Assessment of factual knowledge				
	[K7_W05] Knows and understands, to an increased extent, methods of process and function support, specific to the field of study.		knows and understands methods used for simulation tools for electronic circuits, which are useful also in MEMS design		[SW1] Assessment of factual knowledge				

Subject contents	1 Introduction Evolution of microelectromechanical systems and markets					
Subject contents	1.Introduction. Evolution of microelectromechanical systems and markets.					
	2. MEMS fabrication and materials - patterning, etching, deposition and stress control.					
	3. MEMS fabrication and materials - bonding, heterogeneous integration, packaging and mechanical property.					
	 Review of MEMS elements and their fabrication – sensors. Review of MEMS elements and their fabrication – actuators, energy sources. 					
	6. Applications of MEMS - automobile & home, information processing & telecommunication					
	7. Applications of MEMS – biomedical & chemical					
	8. Application of electronic circuits simulators for electromechanical simulations: current – force analogy					
	9. Application of electronic circuits simulators for electromechanical simulations: voltage – force analogy					
	 10. Design of mechanical elements – beams and springs 11. Design of mechanical MEMS elements with beams and springs 12. Design of mechanical MEMS elements with mechanical resonance 					
	 13. Design of MEMS elements for electronic applications at radio frequencies. 14. Design of MEMS elements with piezo-elements. 15. Integration of MEMS and electronic circuits 					
Prerequisites and co-requisites						
Assessment methods	Subject passing criteria	Passing threshold	Percentage of the final grade			
and criteria	Midterm colloquium	50.0%	50.0%			
	Practical exercises	50.0%	50.0%			
Recommended reading	Basic literature	W. K. Schomburg, Introduction to Microsystem Design, Springer 2011				
		V.K. Varadan, K.J. Vinoy, K. A. Jose, U. Zoelzer, RF Mems & Their Applications, Wiley 2002 M. Esashi, Premium Tutorial, The 11th. Annual IEEE Int. Conf. on Nano/ Micro Engineered and Molecular Systems (IEEE-NEMS 2016), Matsushima and Sendai, Japan, 17-20 April, 2016				

	Supplementary literature	T. M. Adams, R. A. Layton, Introductory MEMS. Fabrication and Applications, Springer 2010			
		B. Bhushan (ed.), "Springer Handbook of Nanotechnology", Springer- Verlag, 2004.			
		H. J. de Los Santos, RF MEMS Circuit Design for Wireless Communications, Artech 2002			
		N. Maluf, K. Williams, An Introduction to Microelectromechanical Systems Engineering, 2 ed., Artech 2004			
		S. Carrara, "Bio/CMOS Interfaces and Co-Design", Springer 2013			
	eResources addresses	Adresy na platformie eNauczanie: Systemy Mikroelektromechaniczne MEMS - 2024 - Moodle ID: 32180			
		https://enauczanie.pg.edu.pl/moodle/course/view.php?id=32180			
Example issues/ example questions/ tasks being completed	Silicon micromachining: surface and bulk. Proces LIGA. MEMS and nanotechnology in massive data storage systems. Bio- and chemical sensors and actuators. Nano- i MEMS technology in optoelectronics. Shape memory alloys in MEMS technology. Using of MEMS technology in making tunable capacitors. Silicon micromotors.				
Work placement	Not applicable				